

## Common Flash Interface Version 1.4 Vendor Specific Extensions

AN201168 provides an overview of the changes implemented between versions 1.3 and 1.4 of the Cypress Flash memory Common Flash Interface (CFI) implementation.

### 1 Introduction

This application note provides an overview of the changes implemented between versions 1.3 and 1.4 of the Cypress® Flash memory Common Flash Interface (CFI) implementation.

CFI is a JEDEC standard database that may be read from a Flash memory. It allows Flash driver software to query the installed device to determine the proper configuration, e.g. memory size, speed, special features, and other characteristics.

The JEDEC CFI standard provides for vendor specific extensions to the basic device information. These extensions provide information about optional device features. As successive device generations add new features new fields are added to the vendor specific extensions area.

### 2 Benefit

There are two main benefits of using CFI:

- Ease of upgrading memory density or features
- Second source availability

CFI-compliant Flash allows the system designer to add and upgrade memory without the inconvenience of modifying Flash driver software to adapt to each new device in a product family. This holds true for new devices of higher density or different sector architecture than available at the time of initial system and driver development.

### 3 CFI Data Structure

From the CFI mode the user can access the following information (Note, the subsequent CFI data tables are provided as examples only. For product-specific CFI data, refer to the Cypress data sheet):

- CFI Identification String - A standard string of characters that any CFI compliant device will display so that Flash driver software can confirm that a CFI device is in use. See [Table 1](#)
- System Interface String - Information on device voltage and timing parameter. See [Table 2](#).
- Device Geometry Definition - Information on command protocol, device size, and sector sizes. See [Table 3](#).
- Primary Vendor-Specific Extended Query - Information on vendor or device specific features that are supported. See [Table 4](#).

Table 1. CFI Query Identification String

Addresses (x16)	Data	Description
10h 11h 12h	0051h 0052h 0059h	Query Unique ASCII String "QRY"
13h 14h	0002h 0000h	Primary OEM Command Set
15h 16h	0040h 0000h	Address for Primary Extended Table
17h 18h	0000h 0000h	Alternate OEM Command Set (00h = none exists)
19h 1Ah	0000h 0000h	Address for Alternate OEM Extended Table (00h = none exists)

Table 2. System Interface String

Addresses (x16)	Data	Description
1Bh	0027h	V <sub>CC</sub> Min. (Write/Erase) D7-D4: volt, D3-D0: mV
1Ch	0036h	V <sub>CC</sub> Max. (Write/Erase) D7-D4: volt, D3-D0: mV
1Dh	0000h	V <sub>PP</sub> Min. voltage (00h = no V <sub>PP</sub> pin present)
1Eh	0000h	V <sub>PP</sub> Max. voltage (00h = no V <sub>PP</sub> pin present)
1Fh	0007h	Typical timeout per single byte/word 2 <sup>N</sup> μs
20h	0007h	Typical timeout for Min. size buffer write 2 <sup>N</sup> μs (00h = not supported)
21h	0000h	Typical timeout per individual block erase 2 <sup>N</sup> ms
22h	0000h	Typical timeout for full chip erase 2 <sup>N</sup> ms (00h = not supported)
23h	0001h	Max. timeout for byte/word write 2 <sup>N</sup> times typical
24h	0005h	Max. timeout for buffer write 2 <sup>N</sup> times typical
25h	0004h	Max. timeout per individual block erase 2 <sup>N</sup> times typical
26h	0000h	Max. timeout for full chip erase 2 <sup>N</sup> times typical (00h = not supported)

Table 3. CFI Device Geometry Definition (Sheet 1 of 2)

Addresses (x16)	Data	Description
27h	0018h	Device size = 2 <sup>N</sup> byte
28h 29h	0002h 0000h	Flash device interface description (refer to CFI publication 100)
2Ah 2Bh	0005h 0000h	Max. number of byte in multi-byte write = 2 <sup>N</sup> (00h = not supported)
2Ch	0001h	Number of erase block regions within device (01h = uniform device, 02h = boot device)
2Dh 2Eh 2Fh 30h	00FFh 0000h 0000h 0001h	Erase block region 1 information (refer to the CFI specification or CFI publication 100)
31h 32h 33h 34h	0000h 0000h 0000h 0000h	Erase block region 2 information (refer to CFI publication 100)

Table 3. CFI Device Geometry Definition (Sheet 2 of 2)

Addresses (x16)	Data	Description
35h 36h 37h 38h	0000h 0000h 0000h 0000h	Erase block region 3 information (refer to CFI publication 100)
39h 3Ah 3Bh 3Ch	0000h 0000h 0000h 0000h	Erase block region 4 information (refer to CFI publication 100)

Table 4. Primary Vendor-Specific Extended Query

Addresses (x16)	Data	Description
40h 41h 42h	0050h 0052h 0049h	Query-unique ASCII string "PRI"
43h	0031h	Major version number, ASCII
44h	0033h	Minor version number, ASCII
45h	0004h	Address Sensitive Unlock (Bits 1-0) 0 = Required, 1 = Not Required Silicon Technology (bits 5-2) 0001 = 0.17 μm
46h	0002h	Erase Suspend 0 = Not Supported, 1 = To Read Only, 2 = To Read & Write
47h	0001h	Sector Protect 00 = Not Supported, x = Number of sectors per group
48h	0000h	Sector Temporary Unprotect 00 = Not Supported, 01 = Supported
49h	0005h	Sector Protect / Unprotect scheme 04 = 29LV800 mode
4Ah	0063h	Simultaneous Operation Number of sectors in all banks except boot block
4Bh	0001h	Burst Mode Type 00 = Not Supported, 01 = Supported
4Ch	0000h	Page Mode Type 00 = Not Supported, 01 = 4 Word Page, 02 = 8 Word Page
4Dh	0085h	ACC (Acceleration) Supply Minimum 00h = Not Supported, D7-D4: Volt, D3-D0: 100mV
4Eh	00C5h	ACC (Acceleration) Supply Maximum 00h = Not Supported, D7-D4: Volt, D3-D0: 100mV
4Fh	00xxh	Top/Bottom Boot Sector Flag 02h = Bottom Boot Device, 03h = Top Boot Device
50h	0000h	Program Suspend. 00h = not supported
57h	0004h	Bank Organization: x = Number of Banks
58h	0023h	Bank A Region Information. x = Number of sectors in bank
59h	0020h	Bank B Region Information. x = Number of sectors in bank
5Ah	0020h	Bank C Region Information. x = Number of sectors in bank
5Bh	0023h	Bank D Region Information. x = Number of sectors in bank

## 4 Changes

The major difference between Cypress memory specific CFI extensions version 1.3 and version 1.4 are the addition of these features in the Primary Vendor-Specific Extended Query section:

- Unlock Bypass
- Secured Silicon Sector size
- Hardware Reset Low Time-out during an embedded algorithm
- Hardware Reset Low Time-out not during an embedded algorithm

- Erase Suspend Time-out Maximum
- Program Suspend Time-out Maximum
- Increased Bank region information from four bank to thirty-two bank

These changes will be implemented in new Cypress Flash devices. The added features are highlighted in [Table 5](#). New Features are highlighted in **bold face** type.

Table 5. Updated Primary Vendor-Specific Extended Query (Sheet 1 of 3)

Address (byte mode)	Data	Description
40h 41h 42h	50h 52h 49h	query-unique ASCII string "PRI"
43h	31h	Major version number ASCII
44h	<b>34h</b>	<b>Minor version ASCII</b>
45h		Address Sensitive Unlock (DQ1,DQ0) 0000 (Hex) = required, 0001 (Hex) = NOT Required Process Technology ( <b>DQ5-DQ2</b> ) <b>0001 (Hex) = 170 nm Floating Gate technology</b> <b>0010 (Hex) = 230 nm MirrorBit<sup>®</sup> technology</b> <b>0011 (Hex) = 130 nm Floating Gate technology</b> <b>0100 = 110 nm MirrorBit<sup>®</sup> technology</b> <b>0101 = 90 nm MirrorBit<sup>®</sup> technology</b> <b>0110 = 90 nm Floating Gate technology</b> <b>0111 = 65 nm MirrorBit Eclipse</b> <b>1000 = 65 nm MirrorBit</b> <b>1001 = 45 nm MirrorBit</b>
46h		Erase Suspend 00 = Not Supported, 01 = To read only, 02 = To read and write
47h		Sector Protect 00 = Not Supported, X = Number of sectors per group
48h		Sector Temporary Unprotect 00 = Not Supported, 01 = Supported
49h		Sector Protect/Unprotect scheme 01 = 29F040 mode 02 = 29F016 mode 03 = 29F400 mode 04 = 29LV800 mode -> RESET# or A9 =Vid 05 = Software command sector locking 06 = New Sector Protect 07 = RESET# or A9 =Vid + New Sector Protect <b>08 = Advanced Sector Protect</b>
4Ah		Simultaneous Operation 00 = Not Supported, X = Total number of sectors in all banks except BOOT BANK
4Bh		<b>Burst Mode Type</b> <b>00 = Not Supported, 01=Supported</b>
4Ch		Page Mode Type 00 = Not Supported, 01 = 4 word Page, 02 = 8 word Page, 03 = 16 word Page
4Dh		ACC (Acceleration) Supply Minimum Bit 7-4 = Hex Value in Volts Bit 3-0 = BCD Value in 100 Millivolts
4Eh		ACC (Acceleration) Supply Maximum Bit 7-4 = Hex Value in Volts Bit 3-0 = BCD Value in 100 Millivolts
4Fh		Top/Bottom Sector Flag 00 = No Boot 01 = 8x8kb, Sectors at TOP and Bottom 02 = Bottom Boot Device 03 = Top Boot Device 04 = Uniform Bottom Boot Device 05 = Uniform Top Boot Device
50h		Program Suspend 00 = Not Supported, 01=Supported
51h		<b>Unlock Bypass</b> <b>00 = Not Supported, 01 = Supported</b>
52h		<b>Secured Silicon Sector (Customer OTP Area) Size 2<sup>N</sup> (Bytes)</b>

Table 5. Updated Primary Vendor-Specific Extended Query (Sheet 2 of 3)

Address (byte mode)	Data	Description
53h		<b>Software Features</b> bit 0: status register polling (1=supported, 0=not supported), bit 1: DQ polling (1=supported, 0=not supported), bit 2: new program suspend/resume commands (1=supported, 0=not supported) bit 3: word programming (1=supported, 0=not supported), bit 4: bit-field programming (1=supported, 0=not supported), bit 5: autodetect programming (1=supported, 0=not supported), bit 6: Refresh/Recovery command (not in data sheet) (1=supported, 0=not supported), bit 7: multiple writes per Line. (1=supported, 0=not supported)
54h		<b>Page Size = 2<sup>N</sup> bytes</b>
55h		<b>Erase Suspend Timeout Maximum &lt; 2<sup>N</sup> (us)</b>
56h		<b>Program Suspend Timeout Maximum &lt; 2<sup>N</sup> (us)</b>
57h		Bank Organization 00 = If data at 4Ah is Zero XX = Number of banks
58h		<b>Bank1 Region Information</b> = Number of sectors in Bank 1
59h		<b>Bank2 Region Information</b> = Number of sectors in Bank 2
5Ah		<b>Bank3 Region Information</b> = Number of sectors in Bank 3
5Bh		<b>Bank4 Region Information</b> = Number of sectors in Bank 4
5Ch		<b>Bank5 Region Information</b> = Number of sectors in Bank 5
5Dh		<b>Bank6 Region Information</b> = Number of sectors in Bank 6
5Eh		<b>Bank7 Region Information</b> = Number of sectors in Bank 7
5Fh		<b>Bank8 Region Information</b> = Number of sectors in Bank 8
60h		<b>Bank9 Region Information</b> = Number of sectors in Bank 9
61h		<b>Bank10 Region Information</b> = Number of sectors in Bank 10
62h		<b>Bank11 Region Information</b> = Number of sectors in Bank 11
63h		<b>Bank12 Region Information</b> = Number of sectors in Bank 12
64h		<b>Bank13 Region Information</b> = Number of sectors in Bank 13
65h		<b>Bank14 Region Information</b> = Number of sectors in Bank 14
66h		<b>Bank15 Region Information</b> = Number of sectors in Bank 15
67h		<b>Bank16 Region Information</b> = Number of sectors in Bank 16
68h		<b>Bank17 Region Information</b> = Number of sectors in Bank 17
69h		<b>Bank18 Region Information</b> = Number of sectors in Bank 18
6Ah		<b>Bank19 Region Information</b> = Number of sectors in Bank 19
6Bh		<b>Bank20 Region Information</b> = Number of sectors in Bank 20
6Ch		<b>Bank21 Region Information</b> = Number of sectors in Bank 21

Table 5. Updated Primary Vendor-Specific Extended Query (Sheet 3 of 3)

Address (byte mode)	Data	Description
6Dh		<b>Bank22 Region Information</b> = Number of sectors in Bank 22
6Eh		<b>Bank23 Region Information</b> = Number of sectors in Bank 23
6Fh		<b>Bank24 Region Information</b> = Number of sectors in Bank 24
70h		<b>Bank25 Region Information</b> = Number of sectors in Bank 25
71h		<b>Bank26 Region Information</b> = Number of sectors in Bank 26
72h		<b>Bank27 Region Information</b> = Number of sectors in Bank 27
73h		<b>Bank28 Region Information</b> = Number of sectors in Bank 28
74h		<b>Bank29 Region Information</b> = Number of sectors in Bank 29
75h		<b>Bank30 Region Information</b> = Number of sectors in Bank 30
76h		<b>Bank31 Region Information</b> = Number of sectors in Bank 31
77h		<b>Bank32 Region Information</b> = Number of sectors in Bank 32
78h		<b>Embedded Hardware Reset Timeout Maximum &lt; 2<sup>N</sup> (μs)</b> Reset with Reset Pin
79h		<b>Non-Embedded Hardware Reset Timeout Maximum &lt; 2<sup>N</sup> (μs)</b> Power on Reset

## 5 Conclusion

These changes enable updated Flash driver software to recognize and make use of new device features.

## Document History Page

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**	-	-	03/22/2004 - 10/21/2009	Initial version Corrected table: Updated Primary Vendor-Specific Extended Query, Address 45h Changed to new format Updated table: Updated Primary Vendor-Specific Extended Query Updated table: Updated Primary Vendor-Specific Extended Query, Address 45h
*A	5015948	MSWI	11/16/2015	Updated in Cypress template
*B	5872369	AESATMP8	09/05/2017	Updated logo and Copyright.

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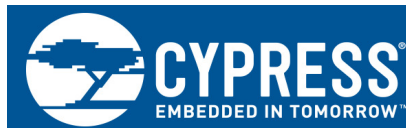
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